

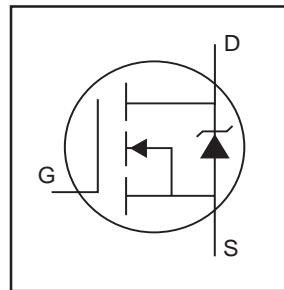
International Rectifier

PD - 95418

IRFI1010NPbF

HEXFET® Power MOSFET

- Advanced Process Technology
- Isolated Package
- High Voltage Isolation = 2.5KVRMS ⑤
- Sink to Lead Creepage Dist. = 4.8mm
- Fully Avalanche Rated
- Lead-Free

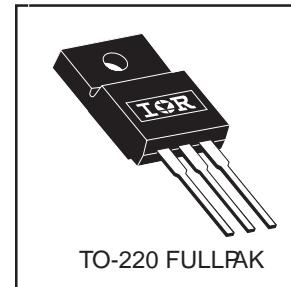


| |
|----------------------------|
| $V_{DSS} = 55V$ |
| $R_{DS(on)} = 0.012\Omega$ |
| $I_D = 49A$ |

Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-220 Fullpak eliminates the need for additional insulating hardware in commercial-industrial applications. The moulding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The Fullpak is mounted to a heatsink using a single clip or by a single screw fixing.



Absolute Maximum Ratings

| | Parameter | Max. | Units |
|---------------------------|--|------------------------|-------|
| $I_D @ T_C = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 49 | |
| $I_D @ T_C = 100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 35 | A |
| I_{DM} | Pulsed Drain Current ①⑥ | 290 | |
| $P_D @ T_C = 25^\circ C$ | Power Dissipation | 58 | W |
| | Linear Derating Factor | 0.38 | W/°C |
| V_{GS} | Gate-to-Source Voltage | ± 20 | V |
| E_{AS} | Single Pulse Avalanche Energy ②⑥ | 360 | mJ |
| I_{AR} | Avalanche Current ① | 43 | A |
| E_{AR} | Repetitive Avalanche Energy ① | 5.8 | mJ |
| dv/dt | Peak Diode Recovery dv/dt ③⑥ | 5.0 | V/ns |
| T_J | Operating Junction and | -55 to + 175 | °C |
| T_{STG} | Storage Temperature Range | | |
| | Soldering Temperature, for 10 seconds | 300 (1.6mm from case) | |
| | Mounting torque, 6-32 or M3 screw | 10 lbf·in (1.1N·m) | |

Thermal Resistance

| | Parameter | Typ. | Max. | Units |
|-----------|---------------------|------|------|-------|
| $R_{θJC}$ | Junction-to-Case | --- | 2.6 | °C/W |
| $R_{θJA}$ | Junction-to-Ambient | --- | 65 | |

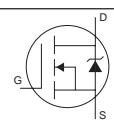
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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|---|--------------------------------------|------|------|-------|---------------------|--|
| $V_{(\text{BR})\text{DSS}}$ | Drain-to-Source Breakdown Voltage | 55 | — | — | V | $V_{GS} = 0V, I_D = 250\mu\text{A}$ |
| $\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$ | Breakdown Voltage Temp. Coefficient | — | 0.06 | — | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}, I_D = 1\text{mA}$ ⑥ |
| $R_{DS(\text{on})}$ | Static Drain-to-Source On-Resistance | — | — | 0.012 | Ω | $V_{GS} = 10V, I_D = 26A$ ④ |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | 2.0 | — | 4.0 | V | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ |
| g_{fs} | Forward Transconductance | 30 | — | — | S | $V_{DS} = 25V, I_D = 43A$ ⑥ |
| I_{DSS} | Drain-to-Source Leakage Current | — | — | 25 | μA | $V_{DS} = 55V, V_{GS} = 0V$ |
| | | — | — | 250 | | $V_{DS} = 44V, V_{GS} = 0V, T_J = 150^\circ\text{C}$ |
| I_{GSS} | Gate-to-Source Forward Leakage | — | — | 100 | nA | $V_{GS} = 20V$ |
| | Gate-to-Source Reverse Leakage | — | — | -100 | | $V_{GS} = -20V$ |
| Q_g | Total Gate Charge | — | — | 130 | nC | $I_D = 43A$ |
| Q_{gs} | Gate-to-Source Charge | — | — | 23 | | $V_{DS} = 44V$ |
| Q_{gd} | Gate-to-Drain ("Miller") Charge | — | — | 53 | | $V_{GS} = 10V, \text{See Fig. 6 and 13}$ ④ ⑥ |
| $t_{d(on)}$ | Turn-On Delay Time | — | 11 | — | ns | $V_{DD} = 28V$ |
| t_r | Rise Time | — | 66 | — | | $I_D = 43A$ |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 40 | — | | $R_G = 3.6\Omega$ |
| t_f | Fall Time | — | 46 | — | | $R_D = 0.62\Omega, \text{See Fig. 10}$ ④ ⑥ |
| L_D | Internal Drain Inductance | — | 4.5 | — | nH | Between lead, 6mm (0.25in.) from package and center of die contact |
| L_S | Internal Source Inductance | — | 7.5 | — | |  |
| C_{iss} | Input Capacitance | — | 2900 | — | pF | $V_{GS} = 0V$ |
| C_{oss} | Output Capacitance | — | 880 | — | | $V_{DS} = 25V$ |
| C_{rss} | Reverse Transfer Capacitance | — | 330 | — | | $f = 1.0\text{MHz}, \text{See Fig. 5}$ ⑥ |
| C | Drain to Sink Capacitance | — | 12 | — | | $f = 1.0\text{MHz}$ |

Source-Drain Ratings and Characteristics

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|----------|---|------|------|------|------------|---|
| I_S | Continuous Source Current (Body Diode) | — | — | 49 | A | MOSFET symbol showing the integral reverse p-n junction diode. |
| I_{SM} | Pulsed Source Current (Body Diode) ① ⑥ | — | — | 290 | |  |
| V_{SD} | Diode Forward Voltage | — | — | 1.3 | V | $T_J = 25^\circ\text{C}, I_S = 26A, V_{GS} = 0V$ ④ |
| t_{rr} | Reverse Recovery Time | — | 81 | 120 | ns | $T_J = 25^\circ\text{C}, I_F = 43A$ |
| Q_{rr} | Reverse Recovery Charge | — | 240 | 370 | nC | $dI/dt = 100A/\mu\text{s}$ ④ ⑥ |

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- ② $V_{DD} = 25V$, starting $T_J = 25^\circ\text{C}$, $L = 390\mu\text{H}$
 $R_G = 25\Omega, I_{AS} = 43A$. (See Figure 12)
- ③ $I_{SD} \leq 43A, dI/dt \leq 260A/\mu\text{s}, V_{DD} \leq V_{(\text{BR})\text{DSS}}, T_J \leq 175^\circ\text{C}$
- ④ Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.
- ⑤ $t=60\text{s}, f=60\text{Hz}$
- ⑥ Uses IRF1010N data and test conditions

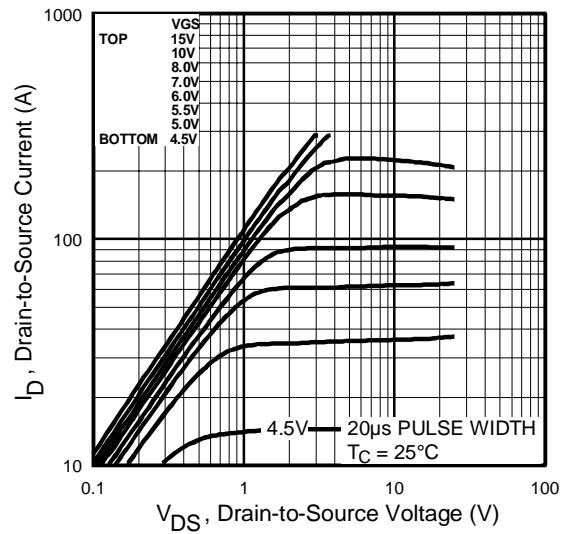


Fig 1. Typical Output Characteristics

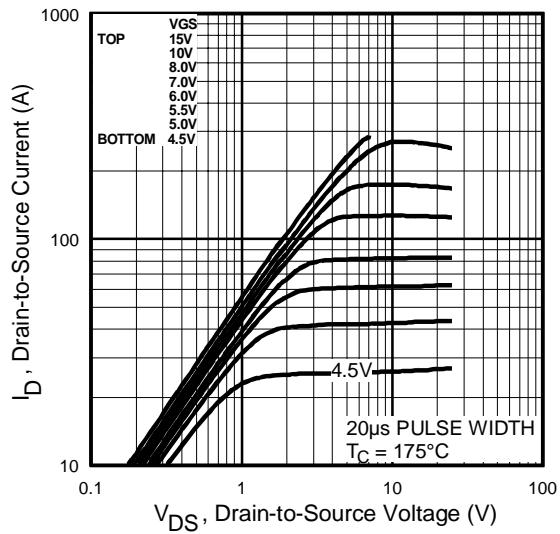


Fig 2. Typical Output Characteristics

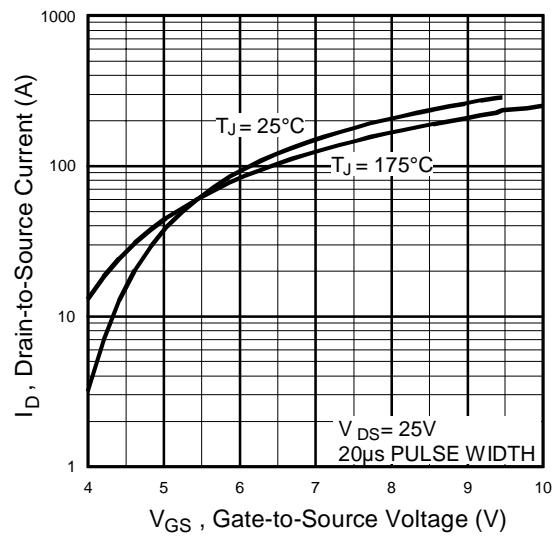


Fig 3. Typical Transfer Characteristics

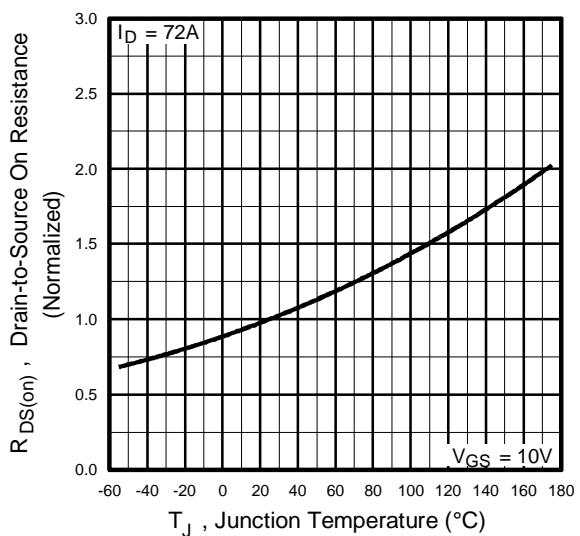


Fig 4. Normalized On-Resistance
Vs. Temperature

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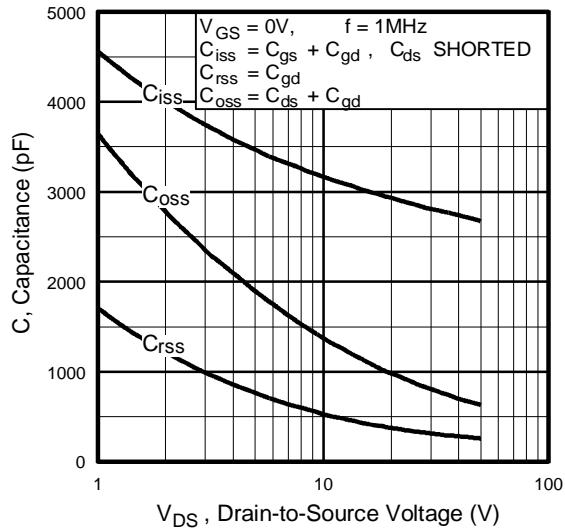


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

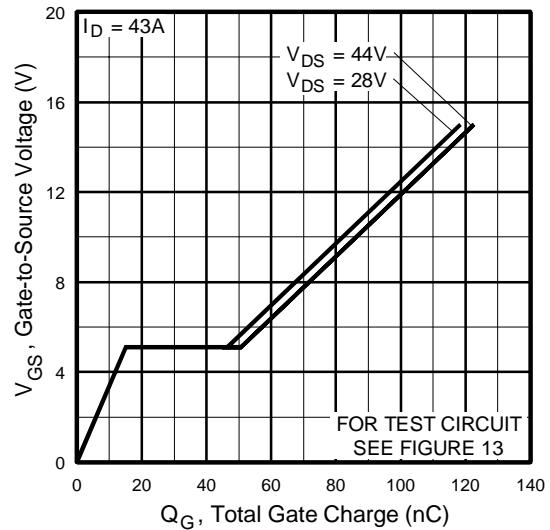


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

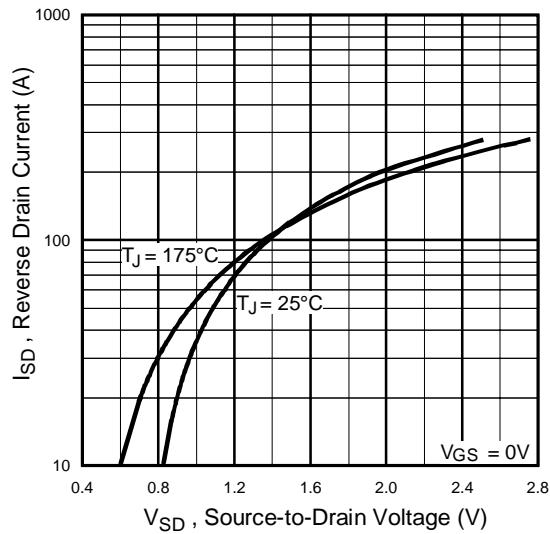


Fig 7. Typical Source-Drain Diode
Forward Voltage

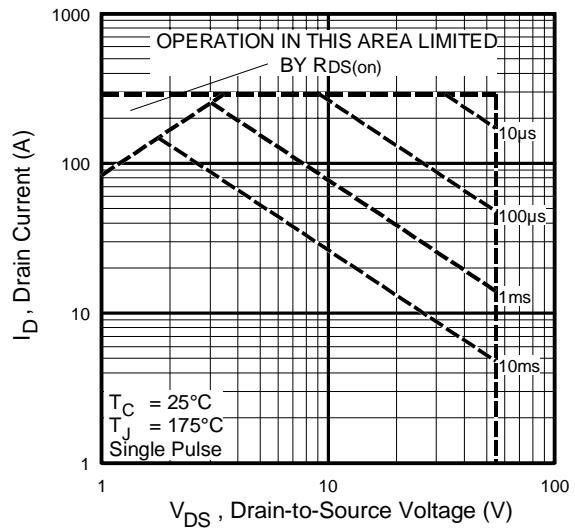


Fig 8. Maximum Safe Operating Area

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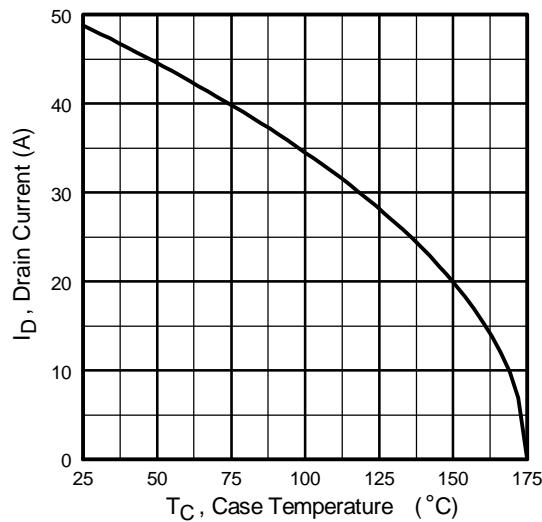


Fig 9. Maximum Drain Current Vs.
Case Temperature

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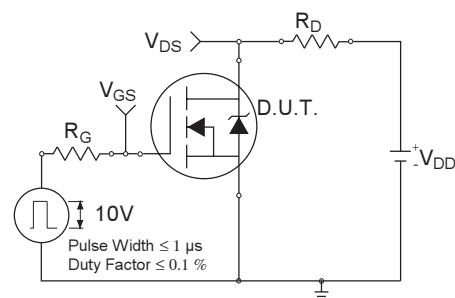


Fig 10a. Switching Time Test Circuit

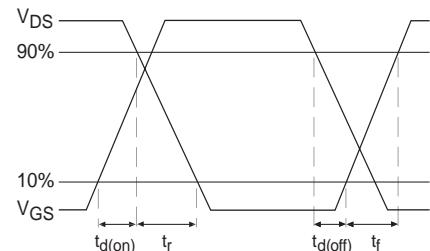


Fig 10b. Switching Time Waveforms

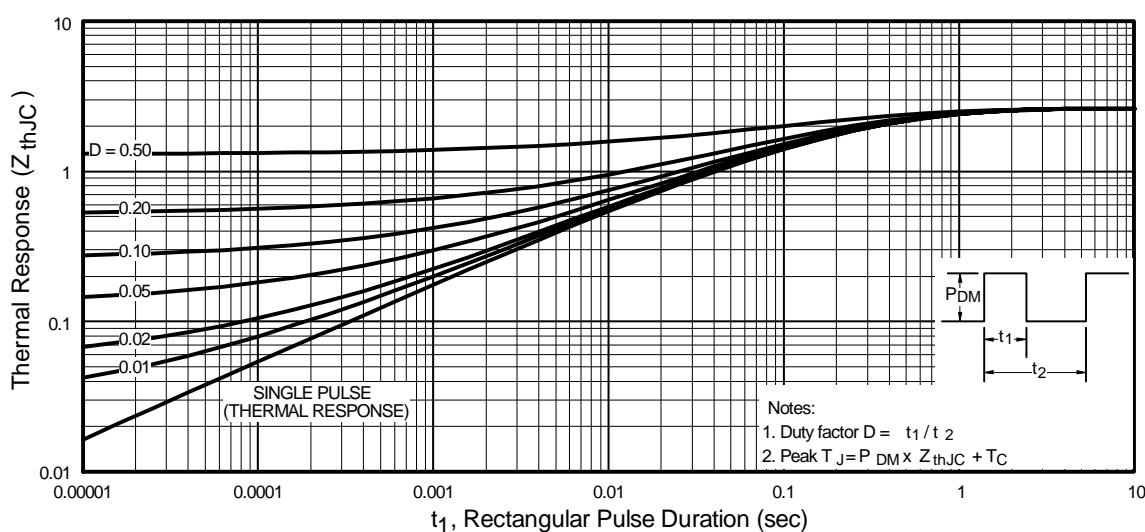


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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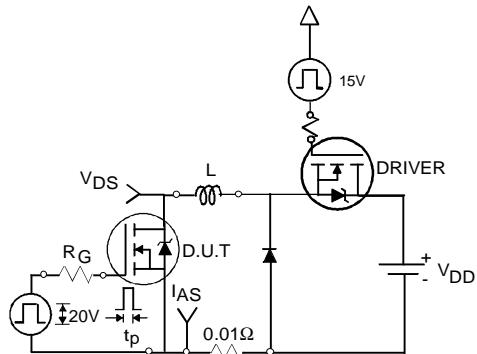


Fig 12a. Unclamped Inductive Test Circuit

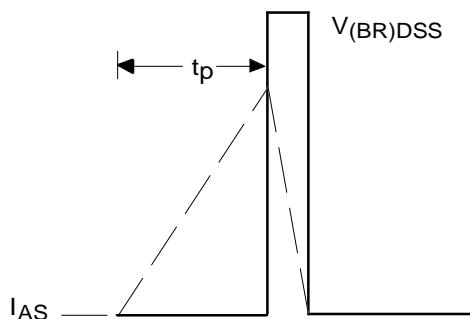


Fig 12b. Unclamped Inductive Waveforms

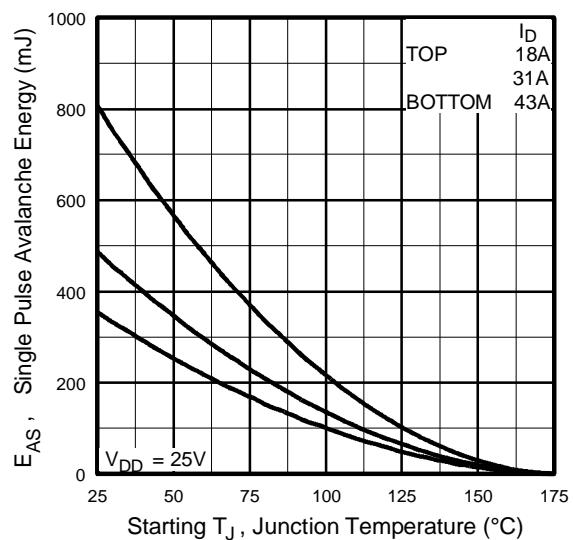


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

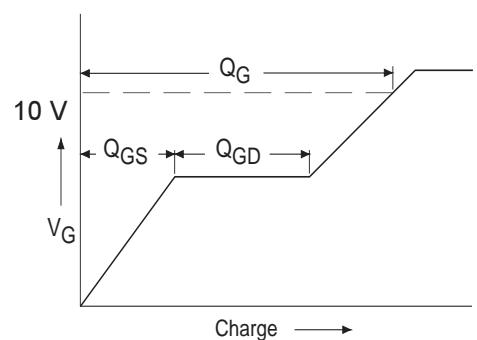


Fig 13a. Basic Gate Charge Waveform

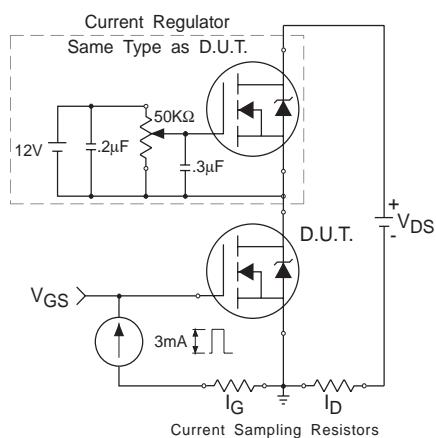
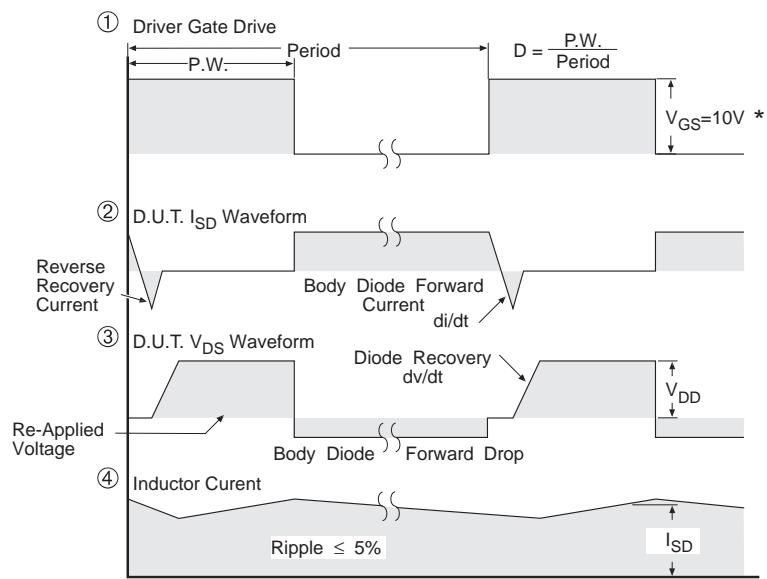
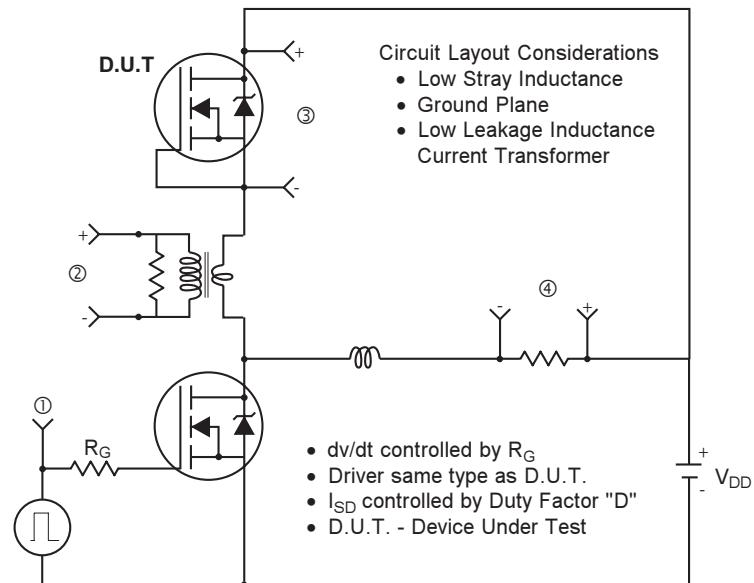


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



* $V_{GS} = 5V$ for Logic Level Devices

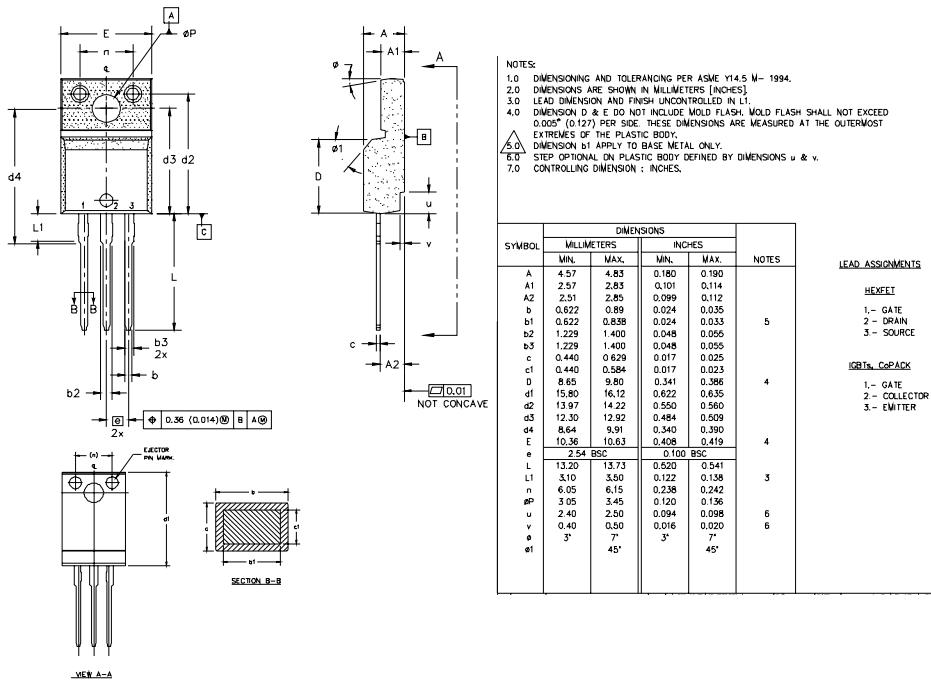
Fig 14. For N-Channel HEXFETS

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TO-220 Full-Pak Package Outline

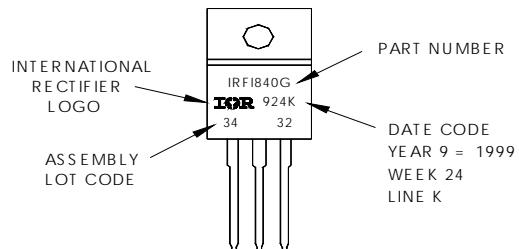
Dimensions are shown in millimeters (inches)



TO-220 Full-Pak Part Marking Information

EXAMPLE: THIS IS AN IRFI840G
WITH ASSEMBLY
LOT CODE 3432
ASSEMBLED ON WW 24 1999
IN THE ASSEMBLY LINE "K"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

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Note: For the most current drawings please refer to the IR website at:
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